



Form 1449 (Modified)	Atty Docket No. NOVL085/NVLS-2875	Application No.: 10/785,235
Information Disclosure Statement By Applicant	Applicant: Wang et al.	
(Use Several Sheets if Necessary)	Filing Date February 23, 2004	Group 2812

U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date

Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
<i>[Signature]</i>	C1	U.S. Office Action mailed July 13, 2005, from U.S Application No. 10/672,311 [Atty Dkt No. NOVLP075/NVLS-000820].
Examiner <i>[Signature]</i>	Date Considered <i>1/3/2006</i>	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



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Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
<i>[Signature]</i>	C1	U.S. Office Action mailed August 24, 2005, from U.S Application No. 10/404,693 [Atty Dkt No. NOVLP064/NVLS-794].
<i>[Signature]</i>	C2	U.S. Office Action mailed September 1, 2005, from U.S Application No. 10/672,305 [Atty Dkt No. NOVLP069/NVLS-000821].
Examiner <i>[Signature]</i>	Date Considered <i>1/3/2006</i>	

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